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### Vishay Semiconductors

# Hyperfast Rectifier, 60 A FRED Pt®



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	60 A				
$V_{R}$	300 V				
V <sub>F</sub> at I <sub>F</sub>	0.85 V				
t <sub>rr</sub> typ.	28 ns				
T <sub>J</sub> max.	175 °C				
Package	TO-247AC 3L				
Circuit configuration	Single				

#### **FEATURES**

- Hyperfast recovery time
- Low forward voltage drop
- Low leakage current
- Soft recovery device
- 175 °C operating junction temperature
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **DESCRIPTION / APPLICATIONS**

VS-60APH03-N3 series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for PDP and use in the output rectification stage for SMPS, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Cathode to anode voltage	$V_{R}$		300	V			
Continuous forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 103 °C	60	۸			
Single pulse forward current	I <sub>FSM</sub>	$T_J = 25$ °C, $t_p = 10$ ms	450	Α			
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C			

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	Ι <sub>R</sub> = 100 μΑ	300	-	ı		
		I <sub>F</sub> = 30 A	-	1.0	1.25		
	V <sub>F</sub>	I <sub>F</sub> = 60 A	-	-	1.45	V	
Forward voltage		I <sub>F</sub> = 30 A, T <sub>J</sub> = 125 °C	-	0.85	1.10		
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 125 °C	-	-	1.30		
Devenue leekeese suument		$V_R = V_R$ rated	-	-	10		
Reverse leakage current	I <sub>R</sub>	$T_J = 125$ °C, $V_R = V_R$ rated -		-	100	μA	
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 300 V	-	70	-	pF	
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	3.5	-	nH	



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1.0 \text{ A}, dI_F/dt = 10$	00 A/ $\mu$ s, V <sub>R</sub> = 30 V	-	28	-		
Payaraa raaayan tima	t <sub>rr</sub>	$I_F = 1.0 \text{ A}, dI_F/dt = 50 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		-	34	-		
Reverse recovery time		T <sub>J</sub> = 25 °C	I <sub>F</sub> = 60 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 200 V	-	42	-	ns A	
		T <sub>J</sub> = 125 °C		-	64	-		
Deals recovery as went	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	3.0	-		
Peak recovery current		T <sub>J</sub> = 125 °C		-	8.5	-		
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	65	-		
		T <sub>J</sub> = 125 °C		-	273	-	IIC	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C	
Thermal resistance, junction to case	R <sub>thJC</sub>		1	0.56	0.80	°C/W	
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	40	C/VV	
Typical thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth, and greased	-	0.4	-		
Approximate Weight			=	6.0	-	g	
Approximate Weight			-	0.22	-	OZ.	
Mounting torque			6.0	-	12	kgf. cm	
Mounting torque			(12)	-	(10)	(lbf.in)	
Marking device		Case style TO-247AC	60APH03				

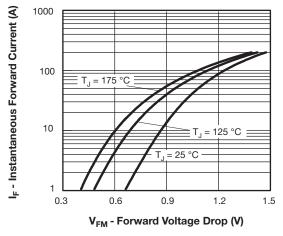


Fig. 1 - Typical Forward Voltage Drop Characteristics

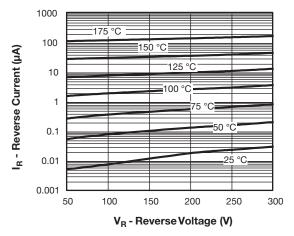


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

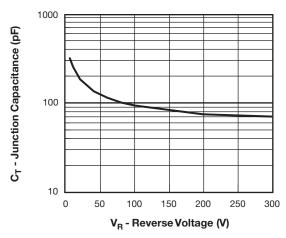


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

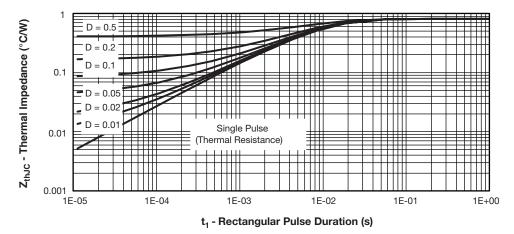


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

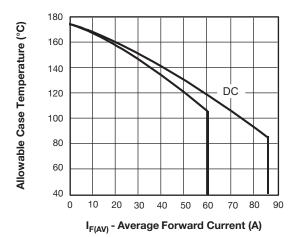


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

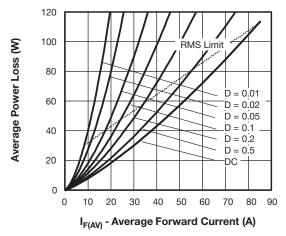
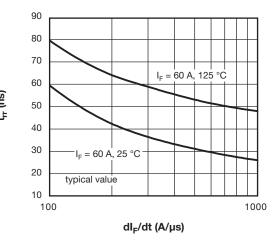


Fig. 6 - Forward Power Loss Characteristics

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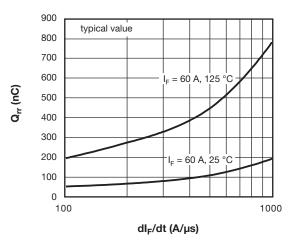
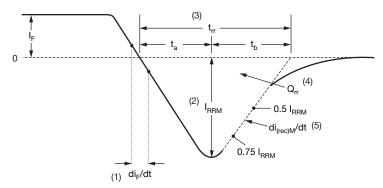


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt



- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm I_{rr}$  to point where a line passing through 0.75  $\rm I_{RRM}$  and 0.50  $\rm I_{RRM}$  extrapolated to zero current.
- (4)  $\mathbf{Q}_{rr}$  area under curve defined by  $\mathbf{t}_{rr}$  and  $\mathbf{I}_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

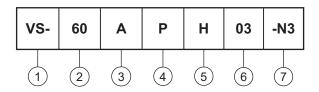
(5) di<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 9 - Reverse Recovery Waveform and Definitions



### **ORDERING INFORMATION TABLE**

Device code



1 - Vishay Semiconductors product

2 - Current rating (60 = 60 A)

3 - Circuit configuration:

A = single diode, 3 pins

4 - P = TO-247 AC

5 - H = hyperfast rectifier

6 - Voltage code (03 = 300 V)

- -N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

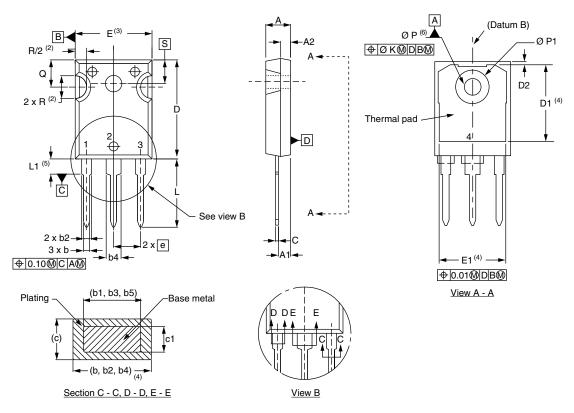
ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-60APH03-N3	25	500	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?96138</u>					
Part marking information <u>www.vishay.com/doc?95007</u>					
SPICE model	www.vishay.com/doc?96075				



### **TO-247AC 3L**

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIN	MILLIMETERS		INCHES	
STINIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MROI MILLIMETERS INCHES		NOTES		
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.35	0.020	0.053	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØK	0.2	254	0.010		
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension Q



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